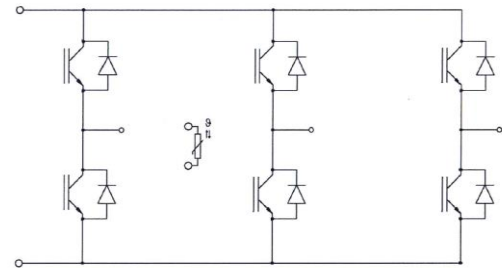
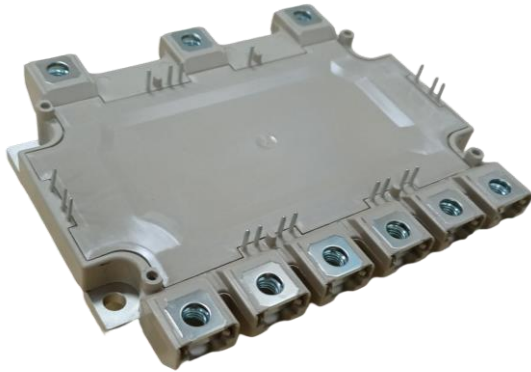


A3 package: 750V 600A IGBT module



等效电路图

Equivalent Circuit Schematic

### Features:

- 750V 600A,  $V_{CE(sat)} = 1.4V @ 25^{\circ}C$
- High RBSOA capability
- Micro pattern trench/FS technology
- Low switching losses
- High SC capability
- Direct Cooled Base Plate with PinFin

### Typical Applications:

- Automotive Applications
- Motor Drives
- Inverters

### 产品特性:

- 750V 600A,  $V_{CE(sat)} = 1.4V @ 25^{\circ}C$
- 高 RBSOA 能力
- 微沟槽/场终止技术
- 低开关损耗
- 高短路能力
- 直接冷却 PinFin 基板

### 典型应用:

- 汽车应用
- 电机驱动
- 逆变器

## IGBT, Inverter / IGBT, 逆变部分

### Maximum Rated Values / 最大标称参数

Collector-emitter voltage 集电极-发射极电压	$T_{vj}=25^{\circ}\text{C}$	$V_{CES}$	750	V
Continuous DC collector current 集电极连续直流电流		$I_{C\text{ nom}}$	600	A
	$T_C=65^{\circ}\text{C}, T_{vj\text{ max}}=175^{\circ}\text{C}$	$I_C$	670	A
Repetitive peak collector current 集电极可重复峰值电流	$t_p=1\text{ms}$	$I_{CRM}$	1200	A
Total power dissipation 功率损耗	$T_C=25^{\circ}\text{C}, T_{vj\text{ max}}=175^{\circ}\text{C}$	$P_{\text{tot}}$	1456	W
Gate-emitter peak voltage 门极-发射极峰值电压		$V_{GES}$	$\pm 20$	V

### Characteristic Values / 性能参数

min. typ. max.

				min.	typ.	max.	
Collector-emitter saturation voltage 集电极-发射极饱和电压	$I_C=600\text{A}, V_{GE}=15\text{V}$ $I_C=600\text{A}, V_{GE}=15\text{V}$	$T_{vj}=25^{\circ}\text{C}$ $T_{vj}=150^{\circ}\text{C}$	$V_{CESat}$	-	1.40 1.60		V
Gate threshold voltage 门极阈值电压	$V_{CE}=V_{GE}, I_C=8\text{mA}$	$T_{vj}=25^{\circ}\text{C}$	$V_{GEth}$	5.00	6.00	7.00	V
Internal gate resistor 内置门极电阻		$T_{vj}=25^{\circ}\text{C}$	$R_{Gint}$	-	0.70	-	$\Omega$
Input capacitance 输入电容	$V_{CE}=25\text{V}, V_{GE}=0\text{V}, f=100\text{kHz}$	$T_{vj}=25^{\circ}\text{C}$	$C_{ies}$	-	TBD	-	nF
Reverse transfer capacitance 反向传输电容	$V_{CE}=25\text{V}, V_{GE}=0\text{V}, f=100\text{kHz}$	$T_{vj}=25^{\circ}\text{C}$	$C_{res}$	-	TBD	-	nF
Gate charge 门极电荷	$V_{GE}=\pm 15\text{V}$		$Q_G$	-	TBD	-	$\mu\text{C}$
Collector-emitter cut-off current 集电极-发射极关断漏电流	$V_{CE}=750\text{V}, V_{GE}=0\text{V}$	$T_{vj}=25^{\circ}\text{C}$	$I_{CES}$	-	-	1.0	mA
Gate-emitter leakage current 门极-发射极漏电流	$V_{CE}=0\text{V}, V_{GE}=20\text{V}$	$T_{vj}=25^{\circ}\text{C}$	$I_{GES}$	-	-	500	nA
Turn-on delay time, inductive load 开通延迟时间, 感性负载	$I_C=600\text{A}, V_{CE}=400\text{V}$ $V_{GE}=-8\text{V}/15\text{V}$ $R_{Gon}=2.0\Omega$	$T_{vj}=25^{\circ}\text{C}$	$t_{don}$	-	150	-	ns
		$T_{vj}=125^{\circ}\text{C}$			172		
		$T_{vj}=150^{\circ}\text{C}$			189		
Rise time, inductive load 上升时间, 感性负载	$I_C=600\text{A}, V_{CE}=400\text{V}$ $V_{GE}=-8\text{V}/15\text{V}$ $R_{Gon}=2.0\Omega$	$T_{vj}=25^{\circ}\text{C}$	$t_r$	-	90	-	ns
		$T_{vj}=125^{\circ}\text{C}$			104		
		$T_{vj}=150^{\circ}\text{C}$			108		
Turn-off delay time, inductive load 关断延迟时间, 感性负载	$I_C=600\text{A}, V_{CE}=400\text{V}$ $V_{GE}=-8\text{V}/15\text{V}$ $R_{Goff}=12\Omega$	$T_{vj}=25^{\circ}\text{C}$	$t_{doff}$	-	988	-	ns
		$T_{vj}=125^{\circ}\text{C}$			1042		
		$T_{vj}=150^{\circ}\text{C}$			1060		
Fall time, inductive load 下降时间, 感性负载	$I_C=600\text{A}, V_{CE}=400\text{V}$ $V_{GE}=-8\text{V}/15\text{V}$ $R_{Goff}=12\Omega$	$T_{vj}=25^{\circ}\text{C}$	$t_f$	-	117	-	ns
		$T_{vj}=125^{\circ}\text{C}$			112		
		$T_{vj}=150^{\circ}\text{C}$			114		
Turn-on energy loss per pulse 开通损耗	$I_C=600\text{A}, V_{CE}=400\text{V}$ $V_{GE}=-8\text{V}/15\text{V}$ $R_{Gon}=2.0\Omega$	$T_{vj}=25^{\circ}\text{C}$	$E_{on}$	-	22.4	-	mJ
		$T_{vj}=125^{\circ}\text{C}$			28.4		
		$T_{vj}=150^{\circ}\text{C}$			32.9		
Turn-off energy loss per pulse 关断损耗	$I_C=600\text{A}, V_{CE}=400\text{V}$ $V_{GE}=-8\text{V}/15\text{V}$ $R_{Goff}=12\Omega$	$T_{vj}=25^{\circ}\text{C}$	$E_{off}$	-	51.7	-	mJ
		$T_{vj}=125^{\circ}\text{C}$			56.0		
		$T_{vj}=150^{\circ}\text{C}$			58.0		
SC data 短路耐受	$V_{CC}=400\text{V}, V_{GE}=-8\text{V}/15\text{V},$ $V_{CE\text{ max}}=V_{CES}-L_s\text{CE}\cdot di/dt$	$T_{vj}=150^{\circ}\text{C}$	$t_{psc}$	6	-	-	$\mu\text{s}$

Thermal resistance, junction to cooling fluid 结-散热器热阻	Per IGBT/单个 IGBT	$R_{thJF}$	-	0.103	-	kW
Temperature under switching conditions 工作温度	$t_{op}$ continuous	$T_{vj op}$	-40	-	150	°C

## Diode, Inverter / 二极管, 逆变部分

### Maximum Rated Values / 最大标称参数

Repetitive peak reverse voltage 可重复反向峰值电压	$T_{vj}=25^{\circ}\text{C}$	$V_{RRM}$		750		V
Continuous DC forward current 可连续正向直流电流		$I_{Fnom}$		600		A
Repetitive peak forward current 可重复正向峰值电流	$I_{FRM}=2 \times I_F$	$I_{FRM}$		1200		A

### Characteristic Values / 性能参数

			min.	typ.	max.		
Forward voltage <sup>1)</sup> 正向通态压降	$I_F=600\text{A}, V_{GE}=0\text{V}$	$T_{vj}=25^{\circ}\text{C}$ $T_{vj}=150^{\circ}\text{C}$	$V_F$	-	1.50 1.42	-	V
Reverse recovery time 反向恢复时间	$I_F=600\text{A}, V_R=400\text{V}$ $di_F/dt=3968\text{A}/\mu\text{s}(T_{vj}=150^{\circ}\text{C})$ $V_{GE}=-8\text{V}$	$T_{vj}=25^{\circ}\text{C}$ $T_{vj}=125^{\circ}\text{C}$ $T_{vj}=150^{\circ}\text{C}$	$t_{rr}$	-	148 217 319	-	ns
Peak reverse recovery current 反向恢复峰值电流	$I_F=600\text{A}, V_R=400\text{V}$ $di_F/dt=3968\text{A}/\mu\text{s}(T_{vj}=150^{\circ}\text{C})$ $V_{GE}=-8\text{V}$	$T_{vj}=25^{\circ}\text{C}$ $T_{vj}=125^{\circ}\text{C}$ $T_{vj}=150^{\circ}\text{C}$	$I_{RM}$	-	232 272 280	-	A
Recovery charge 反向恢复电荷	$I_F=600\text{A}, V_R=400\text{V}$ $di_F/dt=3968\text{A}/\mu\text{s}(T_{vj}=150^{\circ}\text{C})$ $V_{GE}=-8\text{V}$	$T_{vj}=25^{\circ}\text{C}$ $T_{vj}=125^{\circ}\text{C}$ $T_{vj}=150^{\circ}\text{C}$	$Q_R$	-	17.5 29.8 34.9	-	$\mu\text{C}$
Reverse recovery energy 反向恢复损耗	$I_F=600\text{A}, V_R=400\text{V}$ $di_F/dt=3968\text{A}/\mu\text{s}(T_{vj}=150^{\circ}\text{C})$ $V_{GE}=-8\text{V}$	$T_{vj}=25^{\circ}\text{C}$ $T_{vj}=125^{\circ}\text{C}$ $T_{vj}=150^{\circ}\text{C}$	$E_{rec}$	-	4.4 7.5 8.8	-	mJ
Thermal resistance, junction to cooling fluid 结-散热器热阻	Per FRD/单个 FRD		$R_{thJF}$	-	0.165	-	kW
Temperature under switching conditions 工作温度	$t_{op}$ continuous		$T_{vj op}$	-40	-	150	°C

## NTC-Thermistor/ NTC-热敏电阻

### Characteristic Values / 性能参数

			min.	typ.	max.	
Rated resistance 标称电阻	$T_{NTC}=25^{\circ}\text{C}$	$R_{25}$	-	5	-	K $\Omega$
Deviation of R100 R100 偏移值	$T_{NTC}=100^{\circ}\text{C}, R_{100}=493.3\Omega$	$\Delta R/R$	-5	-	5	%
Power dissipation 功率耗散	$T_{NTC}=25^{\circ}\text{C}$	$P_{25}$	-	-	20	mW
B-value B 值	$R_2=R_{25} \exp[B_{25/50}(1/T_2-1/(298.15\text{K}))]$	$B_{25/50}$	-	3375	-	K
	$R_2=R_{25} \exp[B_{25/80}(1/T_2-1/(298.15\text{K}))]$	$B_{25/80}$	-	3414	-	K
	$R_2=R_{25} \exp[B_{25/100}(1/T_2-1/(298.15\text{K}))]$	$B_{25/100}$	-	3436	-	K

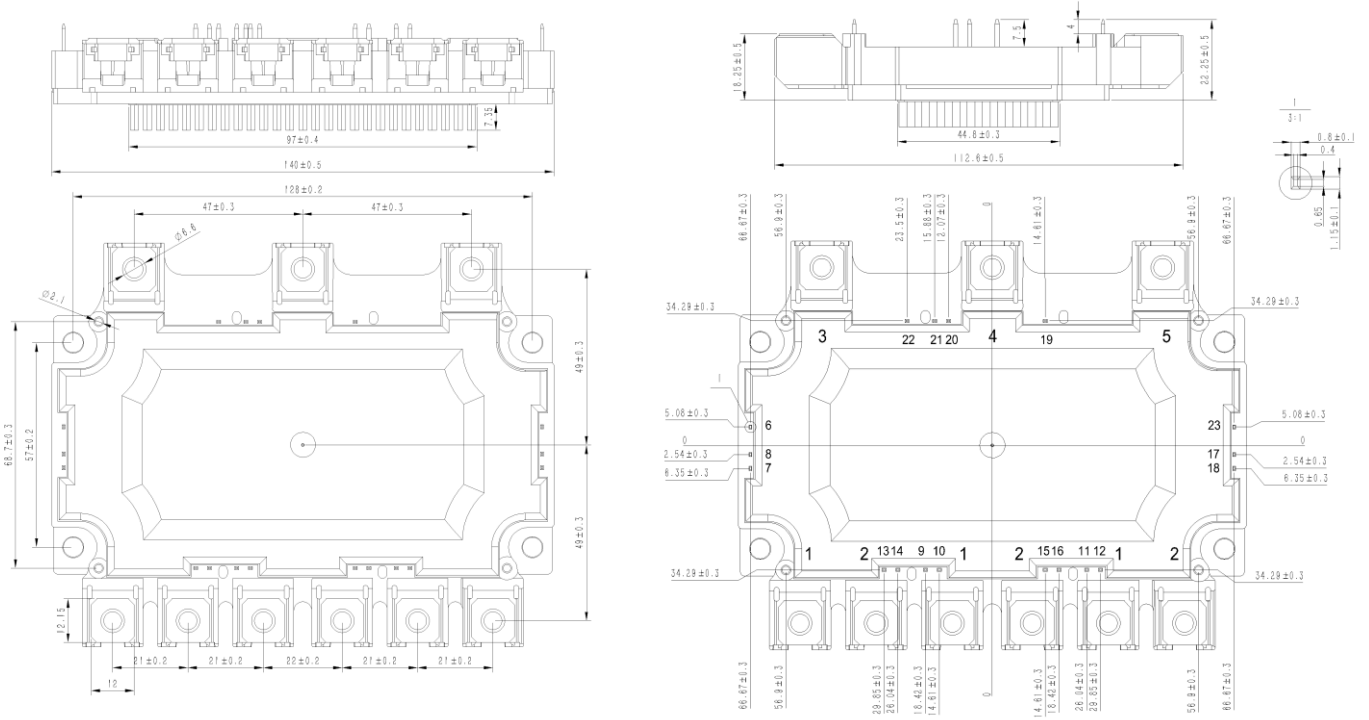
**Module / 模块**

Isolation test voltage 绝缘测试电压	RMS, f=50Hz, t=1min	$V_{ISOL}$	3		KV	
Material of module baseplate 模块底板材料			Cu			
Internal isolation 内部绝缘			$Si_3N_4$			
Creepage distance 爬电距离	Terminal to heatsink Terminal to terminal		12.0 6.1		mm	
Clearance 电气间隙	Terminal to heatsink Terminal to terminal		12.0 6.1		mm	
Comparative tracking index 相对漏电起痕指数		CTI	200 <sup>2)</sup>			
			min.	typ.	max.	
Stray inductance module 模块杂散电感		$L_{SCE}$	-	15	-	nH
Module lead resistance, terminals- chip 模块引脚电阻, 端子-芯片	$T_c=25^\circ C$ , Per Switch	$R_{CC'+EE'}$	-	1.0	-	m $\Omega$
Storage temperature 贮存温度		$T_{stg}$	-40	-	125	$^\circ C$
Mounting torque for module mounting 模块安装力矩	Screw M5 / M5 螺丝 Baseplate to heatsink	M	3.0	-	6.0	Nm
Terminal connection torque 功率端子连接力矩	Screw M6 / M6 螺丝	M	3.0	-	6.0	Nm
Weight 重量		G	-	685	-	g

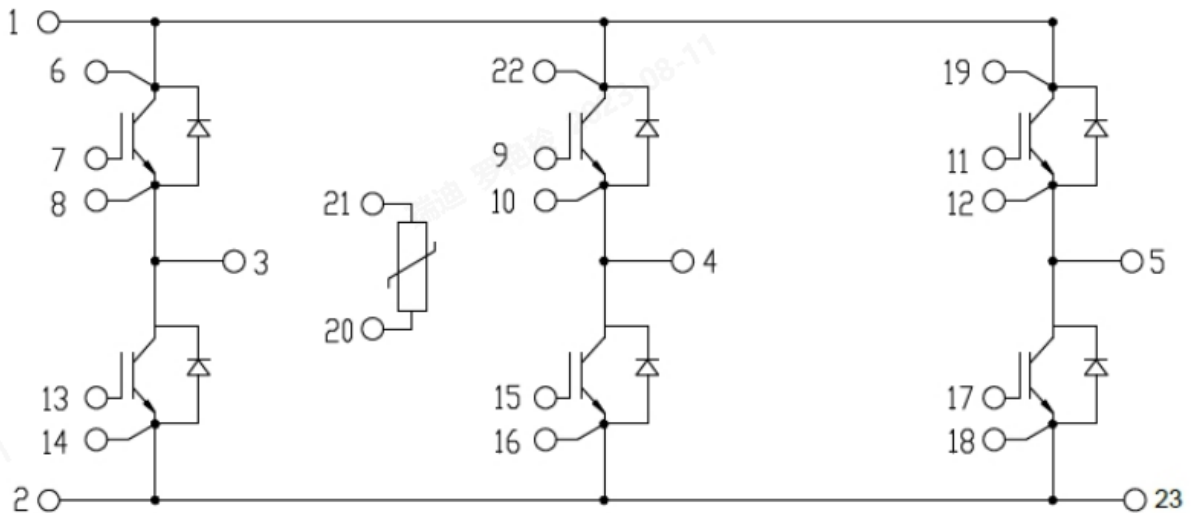
- 1) Terminal impedance is not included.  
不包含端子阻抗。
- 2) CTI is about 200.  
CTI 约等于 200。

**Package Dimension / 封装尺寸**

**Dimensions in Millimeters / 毫米为单位**

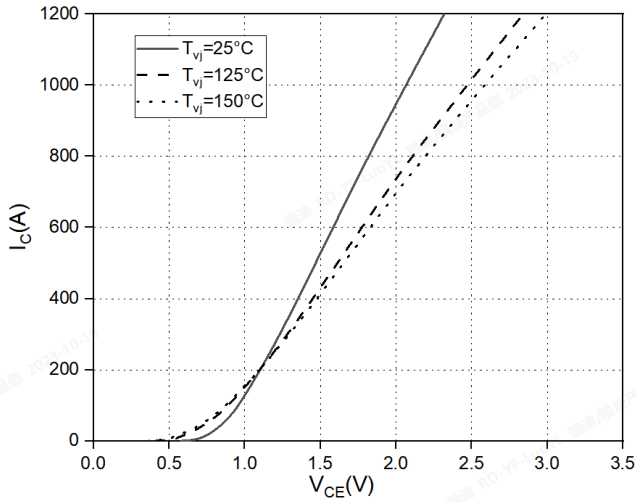


**Internal Circuit / 内部电路**

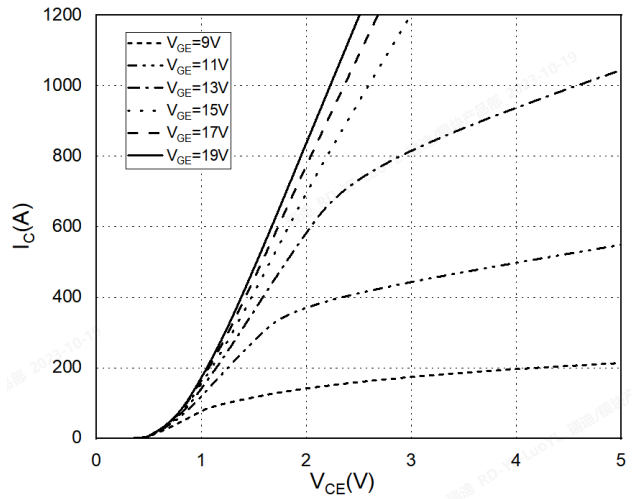


**Circuit Diagram / 曲线图**

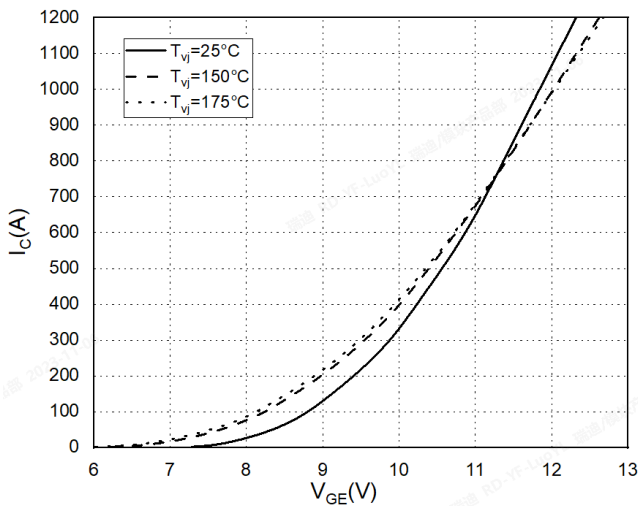
**Output characteristic IGBT, Inverter (typical), Inclusive  $R_{CC+EE}$**   
**IGBT 输出特性, 逆变 (典型值), 包含  $R_{CC+EE}$**   
 $I_c = f(V_{CE}), V_{GE} = 15V$



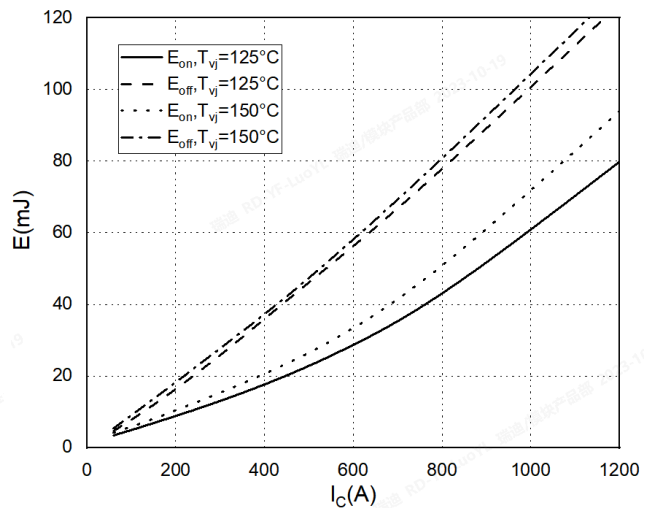
**Output characteristic IGBT, Inverter (typical), Inclusive  $R_{CC+EE}$**   
**IGBT 输出特性, 逆变 ( $T_j = 150^\circ C$ ), 包含  $R_{CC+EE}$**   
 $I_c = f(V_{CE}), T_{vj} = 150^\circ C$



**Transfer characteristic IGBT, Inverter (typical), Inclusive  $R_{CC+EE}$**   
**IGBT 传输特性, 逆变 (典型值), 包含  $R_{CC+EE}$**   
 $I_c = f(V_{GE}), V_{CE} = 20V$

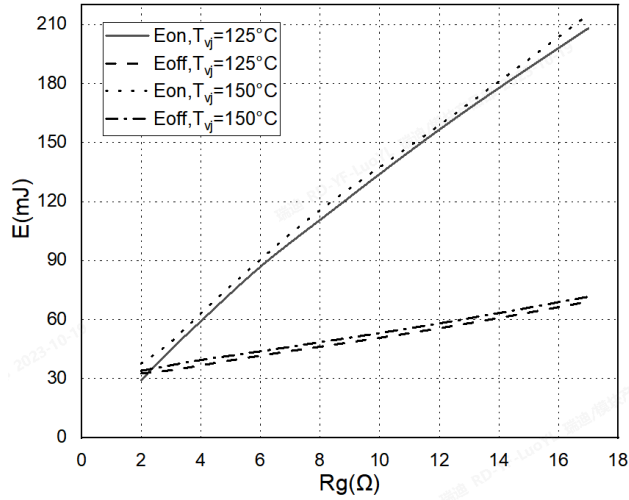


**Switching losses IGBT, Inverter (typical), Inclusive  $R_{CC+EE}$**   
**IGBT 开关损耗, 逆变 (典型值), 包含  $R_{CC+EE}$**   
 $E = f(I_c), V_{GE} = +15V / -8V,$   
 $R_{Gon} = 2\Omega, R_{Goff} = 12\Omega, V_{CE} = 400V$



**Switching losses IGBT, Inverter (typical), Inclusive  $R_{CC'+EE'}$**

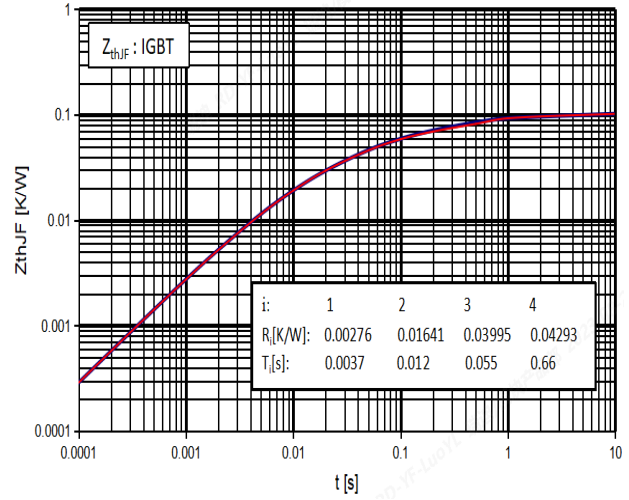
IGBT 开关损耗, 逆变 (典型值), 包含  $R_{CC'+EE'}$   
 $E_{on}=f(R_G)$ ,  $E_{off}=f(R_G)$ ,  
 $V_{GE}=+15V/-8V$ ,  $I_C=600A$ ,  $V_{CE}=400V$



**Transient thermal impedance IGBT, Inerter**

IGBT 瞬态热阻, 逆变

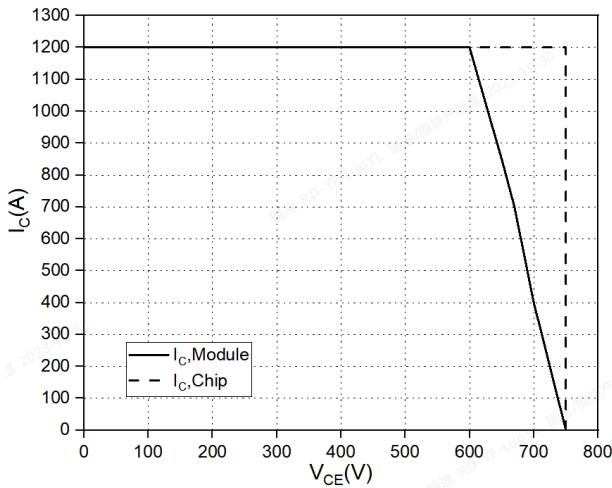
$Z_{thJC}=f(t)$



**Reverse bias safe operating area IGBT, Inverter (RBSOA)**

IGBT 反向安全工作区, 逆变 (RBSOA)

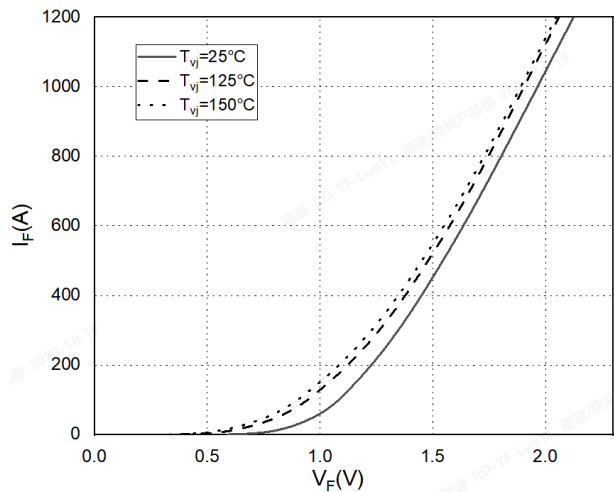
$I_C=f(V_{CE})$ ,  $V_{GE}=+15V/-8V$ ,  $R_{Goff}=12\Omega$ ,  $T_{vj}=150^\circ C$



**Forward characteristic FRD, Inverter (typical), Inclusive  $R_{CC'+EE'}$**

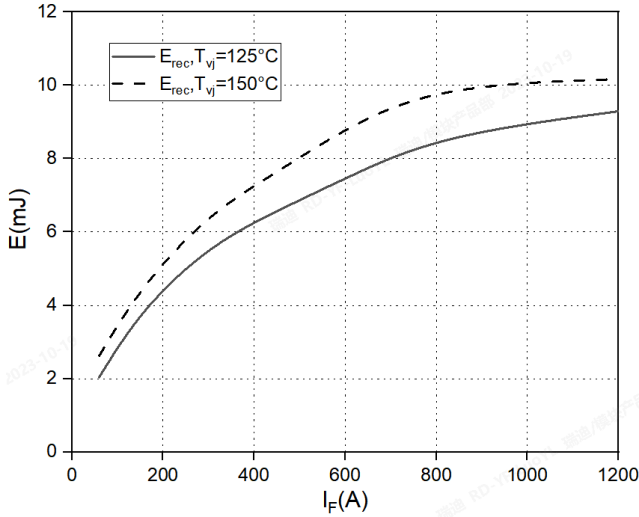
FRD 正向特性, 逆变 (典型值), 包含  $R_{CC'+EE'}$

$I_F=f(V_F)$



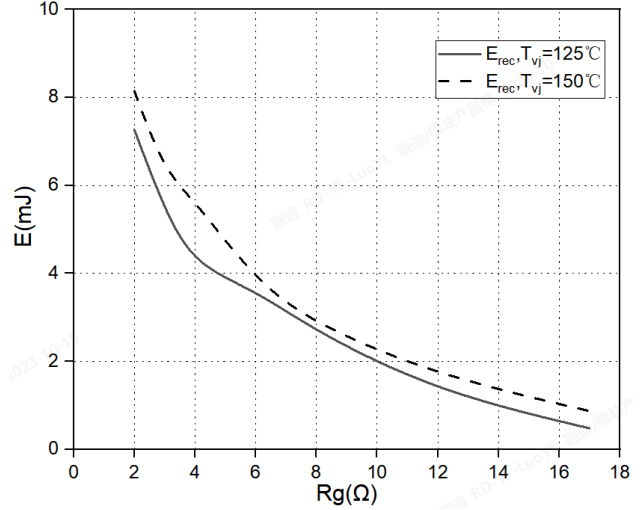
**Switching losses FRD, Inverter (typical),  
Inclusive  $R_{CC'+EE'}$**

FRD 开关损耗, 逆变 (典型值), 包含  $R_{CC'+EE'}$   
 $E_{rec}=f(I_F), R_{Gon}=12\Omega, V_{CE}=400V$



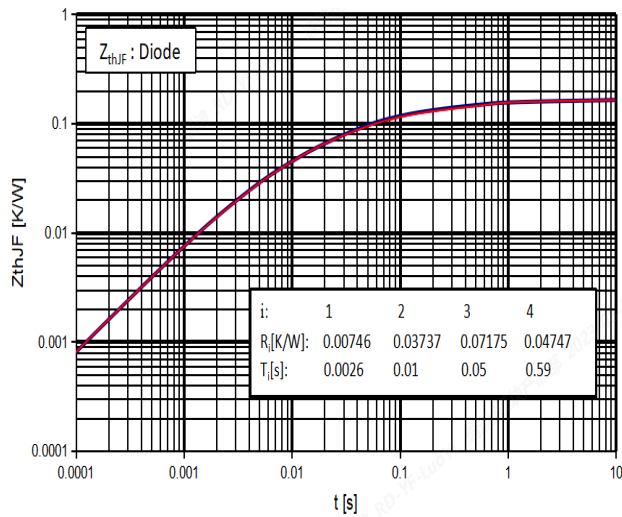
**Switching losses FRD, Inverter (typical),  
Inclusive  $R_{CC'+EE'}$**

FRD 开关损耗, 逆变 (典型值), 包含  $R_{CC'+EE'}$   
 $E_{rec}=f(R_G), I_F=600A, V_{CE}=400V$



**Transient thermal impedance FRD, Inerter**

FRD 瞬态热阻, 逆变  
 $Z_{thJC}=f(t)$



**NTC Thermistor temperature characteristic (typical)**

NTC 热敏电阻  
 $R=f(T)$

